



08-18-03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re United States Patent Application of:

Applicant: Peter Van Buskirk, et al.

Application No.: 09/200,495

Date Filed: November 25, 1998

Title: **OXIDATIVE TOP
ELECTRODE DEPOSITION
PROCESS, AND
MICROELECTRONIC
DEVICE STRUCTURE**

Customer No.: 25559

Docket No.: 2771-337 RCE 2

Examiner: S. Hu

Art Group: 2811

Confirmation No.: 4898

281
#29F
Amendment
YK
11/6/04

EXPRESS MAIL CERTIFICATE

I hereby certify that I am mailing the attached documents to the Commissioner for Patents on the date specified, in an envelope addressed to the Commissioner for Patents, Mail Stop Non-Fee Amendment, P. O. Box 1450, Alexandria, VA 22313-1450, and Express Mailed under the provisions of 37 CFR 1.10.

Candace White

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Signature

August 15, 2002

Date

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**RESPONSE TO MAY 15, 2003 OFFICE ACTION
IN U.S. PATENT APPLICATION NO. 09/200,495**

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